



74VCX1632245

16-BIT DUAL SUPPLY BUS TRANSCEIVER LEVEL TRANSLATOR WITH A SIDE SERIES RESISTOR

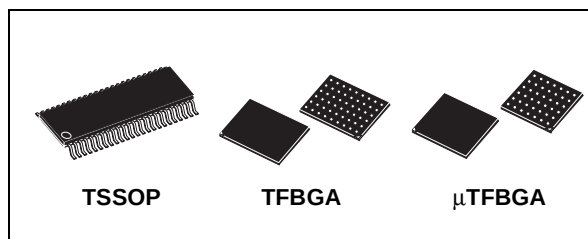
- HIGH SPEED: $t_{PD} = 4.4ns$ (MAX.) at $T_A=85^\circ C$
 $V_{CCA} = 3.0V$ $V_{CCB} = 2.3V$
- LOW POWER DISSIPATION:
 $I_{CCA} = I_{CCB} = 20\mu A$ (MAX.) at $T_A=85^\circ C$
- SYMMETRICAL OUTPUT IMPEDANCE:
 $|I_{OHA}| = I_{OLA} = 8mA$ MIN at
 $V_{CCA} = 3.0V$ $V_{CCB} = 1.65V$ or $2.3V$
 $|I_{OHA}| = I_{OLA} = 18mA$ MIN at
 $V_{CCA} = 2.3V$ $V_{CCB} = 1.65V$
- BALANCED PROPAGATION DELAYS:
 $t_{PLH} \approx t_{PHL}$
- POWER DOWN PROTECTION ON INPUTS
AND OUTPUTS
- 26Ω SERIES RESISTOR ON A SIDE OUTPUTS
- OPERATING VOLTAGE RANGE:
 $V_{CCA}(OPR) = 2.3V$ to $3.6V$ (1.2V Data
Retention)
 $V_{CCB}(OPR) = 1.65V$ to $2.7V$ (1.2V Data
Retention)
- PIN AND FUNCTION COMPATIBLE WITH
74 SERIES 16245
- LATCH-UP PERFORMANCE EXCEEDS
500mA (JESD 17)
- ESD PERFORMANCE:
HBM > 2000V (MIL STD 883 method 3015);
MM > 200V

DESCRIPTION

The 74VCX1632245 is a dual supply low voltage CMOS 16-BIT BUS TRANSCEIVER fabricated with sub-micron silicon gate and five-layer metal wiring C²MOS technology. Designed for use as an interface between a 3.3V bus and a 2.5V or 1.8V bus in a mixed 3.3V/1.8V, 3.3V/2.5V and 2.5V/1.8V supply systems, it achieves high speed operation while maintaining the CMOS low power dissipation.

This IC is intended for two-way asynchronous communication between data buses and the direction of data transmission is determined by nDIR inputs. The enable inputs $\overline{nG}$ can be used to disable the device so that the buses are effectively isolated. The A-port interfaces with the 3V bus, the B-port with the 2.5V and 1.8V bus.

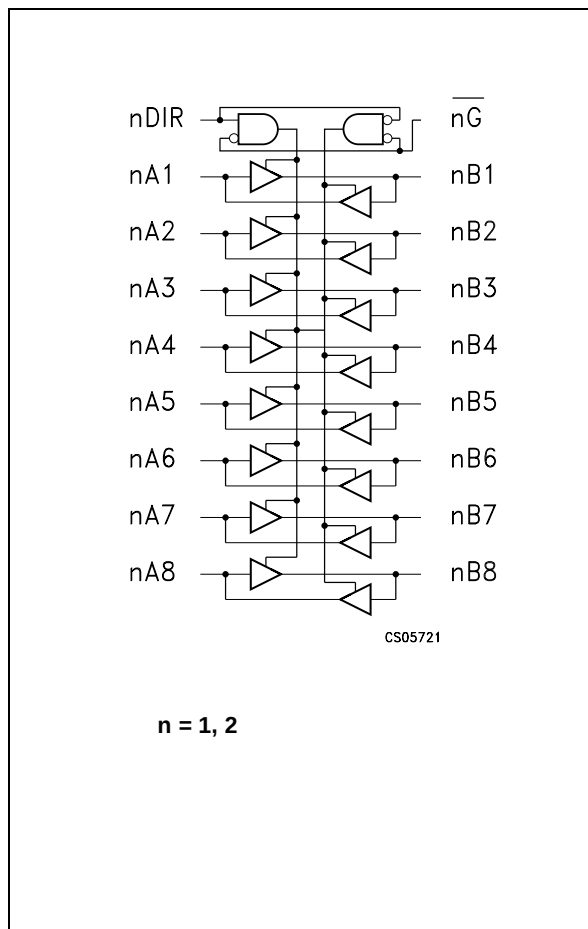
All inputs are equipped with protection circuits against static discharge, giving them 2KV ESD immunity and transient excess voltage. All floating bus terminals during High Z State must be held HIGH or LOW.



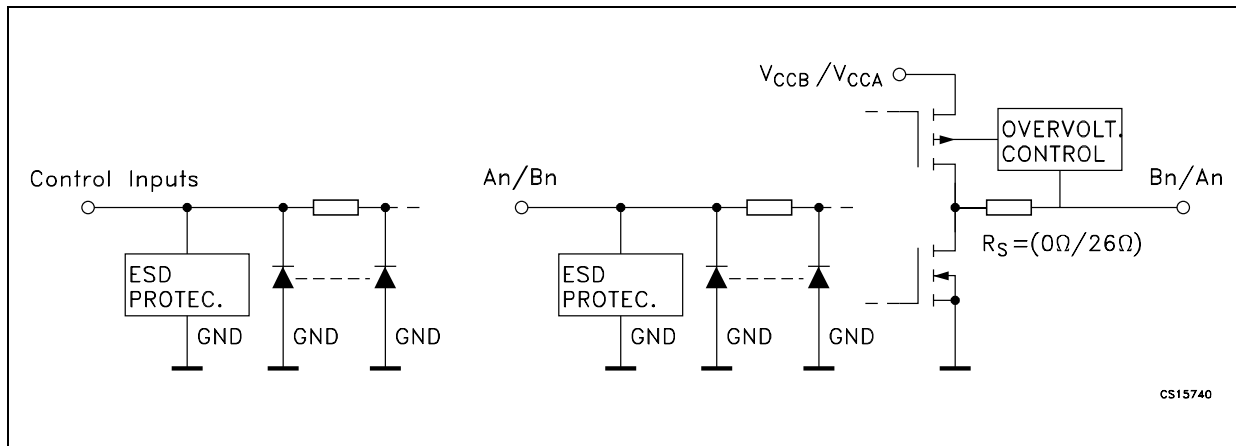
ORDER CODES

PACKAGE	TRAY	T & R
TSSOP48		74VCX1632245TTR
TFBGA54	74VCX1632245LB	74VCX1632245LBR
μTFBGA42	74VCX1632245TB	74VCX1632245TBR

LOGIC DIAGRAM

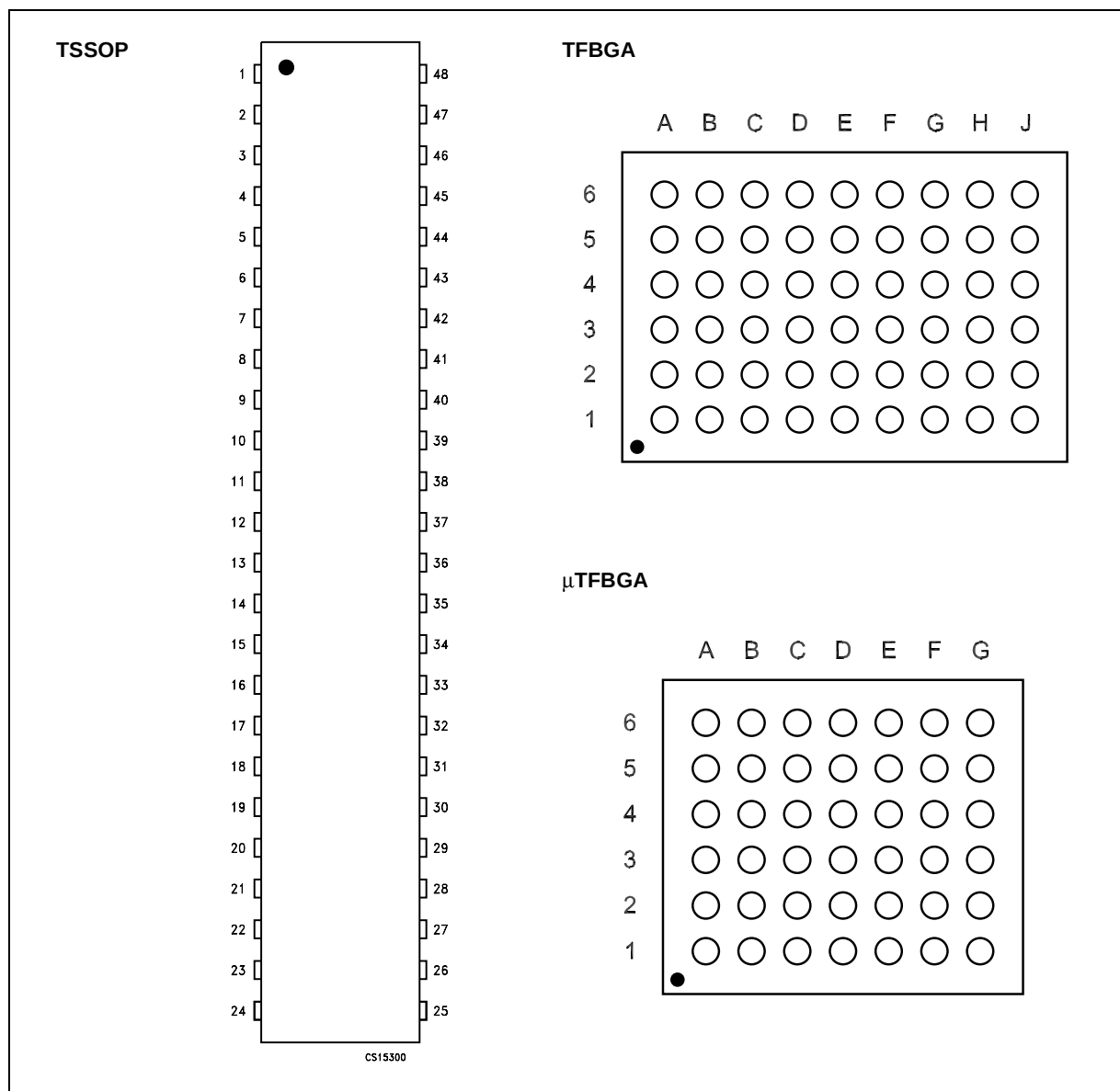


INPUT AND OUTPUT EQUIVALENT CIRCUIT



PIN DESCRIPTION

TFBGA54 PIN N°	μTFBGA42 PIN N°	TSSOP PIN N°	SYMBOL	NAME AND FUNCTION
A3	B3	1	1DIR	Directional Controls
J3	F3	24	2DIR	Directional Controls
A6, B5, B6, C5, C6, D5, D6, E5	A4, A5, A6, B5, B6, C5, C6, D5	47, 46, 44, 43, 41, 40, 38, 37	1A1 to 1A8	Data Inputs/Outputs
E6, F5, F6, G5, G6, H5, H6, J6	D6, E5, E6, F5, F6, G4, G5, G6	36, 35, 33, 32, 30, 29, 27, 26	2A1 to 2A8	Data Inputs/Outputs
A1, B2, B1, C2, C1, D2, D1, E2	A3, A2, A1, B2, B1, C2, C1, D2	2, 3, 5, 6, 8, 9, 11, 12	1B1 to 1B8	Data Inputs/Outputs
E1, F2, F1, G2, G1, H2, H1, J1	D1, E2, E1, F2, F1, G3, G2, G1	13, 14, 16, 17, 19, 20, 22, 23	2B1 to 2B8	Data Inputs/Outputs
J4	F4	25	G2	Output Enable Inputs
A4	B4	48	G1	Output Enable Inputs
D3, D4, E3, E4, F3, F4	C3, C4, E3, E4	4, 10, 15, 21, 28, 34, 39, 45	GND	Ground (0V)
A2, A5, B3, B4, H3, H4, J2, J5	-	-	NC	No Connected
C4, G4	D4	42, 31	VCCA	Positive Supply Voltage
C3, G3	D3	7, 18	VCCB	Positive Supply Voltage

PIN CONNECTION (top view for TSSOP, top through view for BGA)**TRUTH TABLE**

INPUTS		FUNCTION		OUTPUT
$\overline{G}$	DIR	A BUS	B BUS	
L	L	OUTPUT	INPUT	A = B
L	H	INPUT	OUTPUT	B = A
H	X	Z	Z	Z

X=Don't care; Z=High Impedance

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CCA}	Supply Voltage	-0.5 to +4.6	V
V_{CCB}	Supply Voltage	-0.5 to +4.6	V
V_I	DC Input Voltage	-0.5 to +4.6	V
$V_{I/OA}$	DC I/O Voltage (Output disabled)	-0.5 to +4.6	V
$V_{I/OB}$	DC I/O Voltage (Output disabled)	-0.5 to +4.6	V
$V_{I/OA}$	DC I/O Voltage	-0.5 to $V_{CCA} + 0.5$	V
$V_{I/OB}$	DC I/O Voltage	-0.5 to $V_{CCB} + 0.5$	V
I_{IK}	DC Input Diode Current	- 20	mA
I_{OK}	DC Output Diode Current	- 50	mA
I_{OA}	DC Output Current	± 50	mA
I_{OB}	DC Output Current	± 50	mA
I_{CCA}	DC V_{CC} or Ground Current	± 100	mA
I_{CCB}	DC V_{CC} or Ground Current	± 100	mA
P_d	Power Dissipation	400	mW
T_{stg}	Storage Temperature	-65 to +150	°C
T_L	Lead Temperature (10 sec)	300	°C

Absolute Maximum Ratings are those value beyond which damage to the device may occur. Functional operation under these conditions is not implied

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Value	Unit
V_{CCA}	Supply Voltage	2.3 to 3.6	V
V_{CCB}	Supply Voltage	1.65 to 2.7	V
V_I	Input Voltage (Dir, $\overline{G}$)	0 to V_{CCB}	V
$V_{I/OA}$	I/O Voltage	0 to V_{CCA}	V
$V_{I/OB}$	I/O Voltage	0 to V_{CCB}	V
T_{op}	Operating Temperature	-40 to 85	°C
dt/dv	Input Rise and Fall Time (note 1)	0 to 10	ns/V

1) V_{IN} from 0.8V to 2.0V at $V_{CC} = 3.0V$

DC SPECIFICATION FOR V_{CCA}

Symbol	Parameter	Test Condition			Value					Unit
		V _{CCB} (*) (V)	V _{CCA} (*) (V)		T _A = 25 °C			-40 to 85 °C		
					Min.	Typ.	Max.	Min.	Max.	
V _{IHA}	High Level Input Voltage (An)	1.8	2.5		1.6			1.6		V
		1.8	3.3		2.0			2.0		
		2.5	3.3		2.0			2.0		
V _{ILA}	Low Level Input Voltage (An)	1.8	2.5				0.7		0.7	V
		1.8	3.3				0.8		0.8	
		2.5	3.3				0.8		0.8	
V _{OHA}	High Level Output Voltage	2.3	3.0	I _O =-100μA	2.8			2.8		V
		2.3	3.0	I _O =-8mA	2.4			2.4		
		1.65	3.0	I _O =-8mA	2.4			2.4		
		1.65	2.3	I _O =-6mA	1.8			1.8		
V _{OLA}	Low Level Output Voltage	2.3	3.0	I _O =100μA			0.2		0.2	V
		2.3	3.0	I _O =8mA			0.55		0.55	
		1.65	3.0	I _O =8mA			0.55		0.55	
		1.65	2.3	I _O =6mA			0.40		0.40	
I _{IA}	Input Leakage Current	2.7	3.6	V _I = V _{CC} or GND			± 0.5		± 5	μA
I _{OZA}	High Impedance Output Leakage Current	2.7	3.6	V _{IA} = GND or 3.6V V _{IB} = V _{IHB} or V _{ILB} G = V _{CCB}			± 1.0		± 10	μA
I _{OFF}	Power Off Leakage Current	0	0	V _{IA} = GND to 3.6V V _{IB} = GND to 3.6V G, Dir = GND to 3.6V			± 1.0		± 10	μA
I _{CCIA}	Quiescent Supply Current	1.95	3.6	V _{IA} =V _{CCA} or GND V _{IB} =V _{CCB} or GND			2		20	μA
		1.95	2.7							
		2.7	3.6							
ΔI _{CCIA}	Maximum Quiescent Supply Current / Input (An)	2.7	3.6	V _{IA} =V _{CCA} - 0.6V V _{IB} =V _{CCB} or GND					0.75	mA
		1.95	3.6							
		1.95	2.7							

(*) V_{CC} range = 3.3 ± 0.3 ; $2.5 \pm 0.2\text{V}$; $1.8 \pm 0.15\text{V}$

DC SPECIFICATION FOR V_{CCB}

Symbol	Parameter	Test Condition			Value					Unit
		V _{CCB} (V) (*)	V _{CCA} (V) (*)		T _A = 25 °C			-40 to 85 °C		
					Min.	Typ.	Max.	Min.	Max.	
V _{IHB}	High Level Input Voltage (Bn, Dir, G)	1.8	2.5		0.65V _{CCB}			0.65V _{CCB}		V
		1.8	3.3		0.65V _{CCB}			0.65V _{CCB}		
		2.5	3.3		1.6			1.6		
V _{ILB}	Low Level Input Voltage (Bn, Dir, G)	1.8	2.5				0.35V _{CCB}		0.35V _{CCB}	V
		1.8	3.3				0.35V _{CCB}		0.35V _{CCB}	
		2.5	3.3				0.7		0.7	
V _{OHB}	High Level Output Voltage	2.3	3.0	I _O =-100μA	2.1			2.1		V
		2.3	3.0	I _O =-18mA	1.7			1.7		
		1.65	3.0	I _O =-6mA	1.25			1.25		
		1.65	2.3	I _O =-6mA	1.25			1.25		
V _{OLB}	Low Level Output Voltage	2.3	3.0	I _O =100μA			0.2		0.2	V
		2.3	3.0	I _O =18mA			0.60		0.60	
		1.65	3.0	I _O =6mA			0.30		0.30	
		1.65	2.3	I _O =6mA			0.30		0.30	
I _{IB}	Input Leakage Current	2.7	3.6	V _I = V _{CC} or GND			± 0.5		± 5	μA
I _{OZB}	High Impedance Output Leakage Current	2.7	3.6	V _{IA} = V _{IHA} or V _{ILA} V _{IB} = GND or 2.7V $\overline{G}$ = V _{CCB}			± 1.0		± 10	μA
I _{CCIB}	Quiescent Supply Current	1.95	3.6	V _{IA} =V _{CCA} or GND			2		20	μA
		1.95	2.7	V _{IB} =V _{CCB} or GND						
		2.7	3.6	Dir or $\overline{G}$ =V _{CCB} or GND						
ΔI _{CCIB}	Maximum Quiescent Supply Current / Input (Bn, DIR, G)	2.7	3.6	V _{IB} =V _{CCB} - 0.6V V _{IA} =V _{CCA} or GND					0.75	mA
		1.95	3.6							
		1.95	2.7							

(*) V_{CC} range = 3.3 ± 0.3 ; $2.5 \pm 0.2\text{V}$; $1.8 \pm 0.15\text{V}$

DYNAMIC SWITCHING CHARACTERISTICS

Symbol	Parameter	Test Condition			Value					Unit
		V _{CCB} (V)	V _{CCA} (V)		T _A = 25 °C			-40 to 85 °C		
					Min.	Typ.	Max.	Min.	Max.	
V _{OLPA}	Dynamic Low Level Quiet An Output	1.8	2.5	C _L =30pF V _{IL} =0V V _{IH} =V _{CC}		0.25				V
		1.8	3.3			0.35				
		2.5	3.3			0.35				
V _{OLPB}	Dynamic Low Level Quiet Bn Output	1.8	2.5	C _L =30pF V _{IL} =0V V _{IH} =V _{CC}		0.25				V
		1.8	3.3			0.25				
		2.5	3.3			0.6				
V _{OLVA}	Dynamic Low Level Quiet An Output	1.8	2.5	C _L =30pF V _{IL} =0V V _{IH} =V _{CC}		-0.25				V
		1.8	3.3			-0.35				
		2.5	3.3			-0.35				
V _{OLVB}	Dynamic Low Level Quiet Bn Output	1.8	2.5	C _L =30pF V _{IL} =0V V _{IH} =V _{CC}		-0.25				V
		1.8	3.3			-0.25				
		2.5	3.3			-0.6				
V _{OHVA}	Dynamic Low Level Quiet An Output	1.8	2.5	C _L =30pF V _{IL} =0V V _{IH} =V _{CC}		2.1				V
		1.8	3.3			2.6				
		2.5	3.3			2.6				
V _{OHVB}	Dynamic Low Level Quiet Bn Output	1.8	2.5	C _L =30pF V _{IL} =0V V _{IH} =V _{CC}		1.7				V
		1.8	3.3			1.7				
		2.5	3.3			2.0				

AC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Test Condition			Value		Unit
		V _{CCB} (V)	V _{CCA} (V)		-40 to 85 °C		
					Min.	Max.	
t _{PLH} t _{PHL}	Propagation Delay Time An to Bn	1.8 ± 0.15	2.5 ± 0.2	C _L = 30 pF R _L = 500 Ω	1.0	5.8	ns
		1.8 ± 0.15	3.3 ± 0.3		1.0	6.2	
		2.5 ± 0.2	3.3 ± 0.3		1.0	4.4	
t _{PLH} t _{PHL}	Propagation Delay Time Bn to An	1.8 ± 0.15	2.5 ± 0.2	C _L = 30 pF R _L = 500 Ω	1.0	5.5	ns
		1.8 ± 0.15	3.3 ± 0.3		1.0	5.1	
		2.5 ± 0.2	3.3 ± 0.3		1.0	4.0	
t _{PZL} t _{PZH}	Output Enable Time G to An	1.8 ± 0.15	2.5 ± 0.2	C _L = 30 pF R _L = 500 Ω	1.0	5.3	ns
		1.8 ± 0.15	3.3 ± 0.3		1.0	5.1	
		2.5 ± 0.2	3.3 ± 0.3		1.0	4.0	
t _{PZL} t _{PZH}	Output Enable Time G to Bn	1.8 ± 0.15	2.5 ± 0.2	C _L = 30 pF R _L = 500 Ω	1.0	8.3	ns
		1.8 ± 0.15	3.3 ± 0.3		1.0	8.2	
		2.5 ± 0.2	3.3 ± 0.3		1.0	4.6	
t _{PLZ} t _{PHZ}	Output Disable Time G to An	1.8 ± 0.15	2.5 ± 0.2	C _L = 30 pF R _L = 500 Ω	1.0	5.2	ns
		1.8 ± 0.15	3.3 ± 0.3		1.0	5.6	
		2.5 ± 0.2	3.3 ± 0.3		1.0	4.8	
t _{PLZ} t _{PHZ}	Output Disable Time G to Bn	1.8 ± 0.15	2.5 ± 0.2	C _L = 30 pF R _L = 500 Ω	1.0	4.6	ns
		1.8 ± 0.15	3.3 ± 0.3		1.0	4.5	
		2.5 ± 0.2	3.3 ± 0.3		1.0	4.4	
t _{OSLH} t _{OSHL}	Output To Output Skew Time (note1, 2)	1.8 ± 0.15	2.5 ± 0.2	C _L = 30 pF R _L = 500 Ω		0.5	ns
		1.8 ± 0.15	3.3 ± 0.3			0.5	
		2.5 ± 0.2	3.3 ± 0.3			0.75	

1) Skew is defined as the absolute value of the difference between the actual propagation delay for any two outputs of the same device switching in the same direction, either HIGH or LOW (t_{OSLH} = |t_{PLHm} - t_{PLHn}|, t_{OSHL} = |t_{PHLm} - t_{PHLn}|)

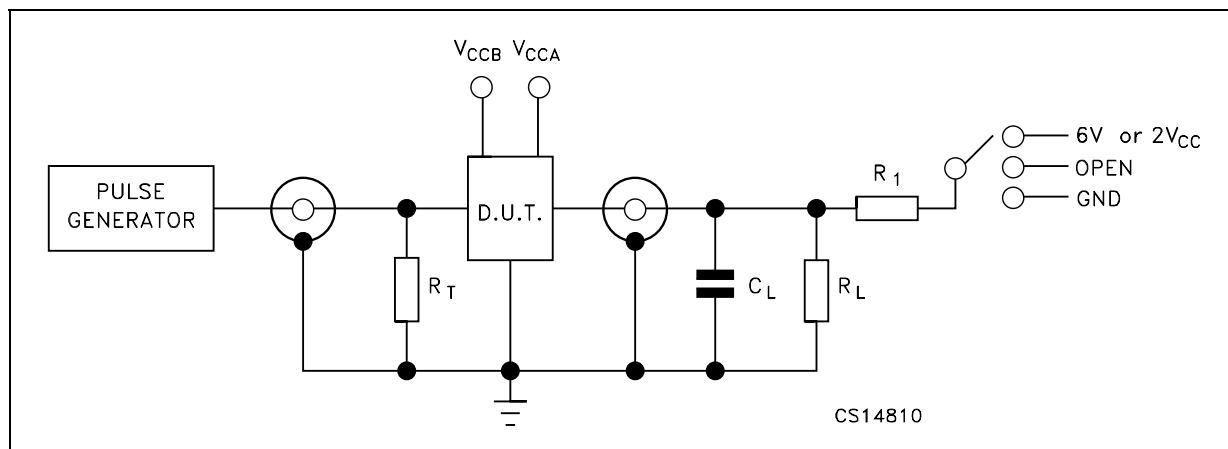
2) Parameter guaranteed by design

CAPACITANCE CHARACTERISTICS

Symbol	Parameter	Test Condition			Value					Unit
		V _{CCB} (V)	V _{CCA} (V)		T _A = 25 °C			-40 to 85 °C		
					Min.	Typ.	Max.	Min.	Max.	
C _{INB}	Input Capacitance	open	open			5				pF
C _{I/O}	Input/Output Capacitance	2.5	3.3			6				pF
C _{PD}	Power Dissipation Capacitance	2.5	3.3	f=10MHz		28				pF
		1.8	3.3			28				pF

1) C_{PD} is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. (Refer to Test Circuit). Average current can be obtained by the following equation. I_{CC(opr)} = C_{PD} × V_{CC} × f_{IN} + I_{CC}/16 (per circuit)

TEST CIRCUIT



TEST	SWITCH
t_{PLH} , t_{PHL}	Open
t_{PZL} , t_{PLZ} ($V_{CC} = 3.0$ to $3.6V$)	6V
t_{PZL} , t_{PLZ} ($V_{CC} = 2.3$ to $2.7V$ or $V_{CC} = 1.65$ to $1.95V$)	$2V_{CC}$
t_{PZH} , t_{PHZ}	GND

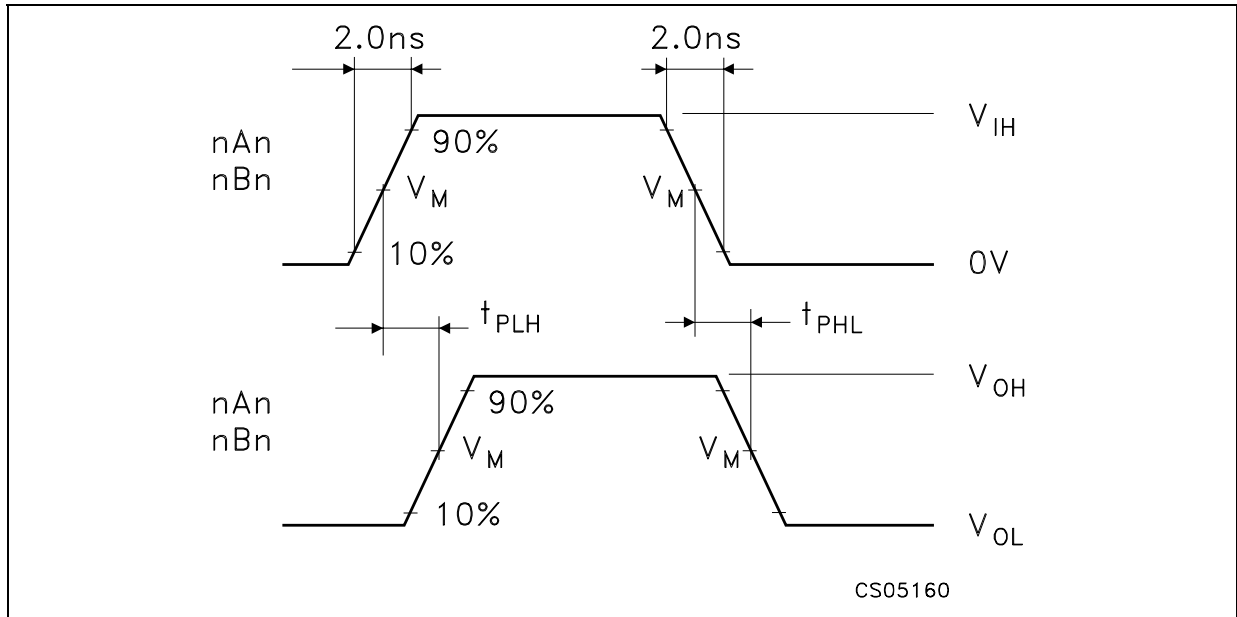
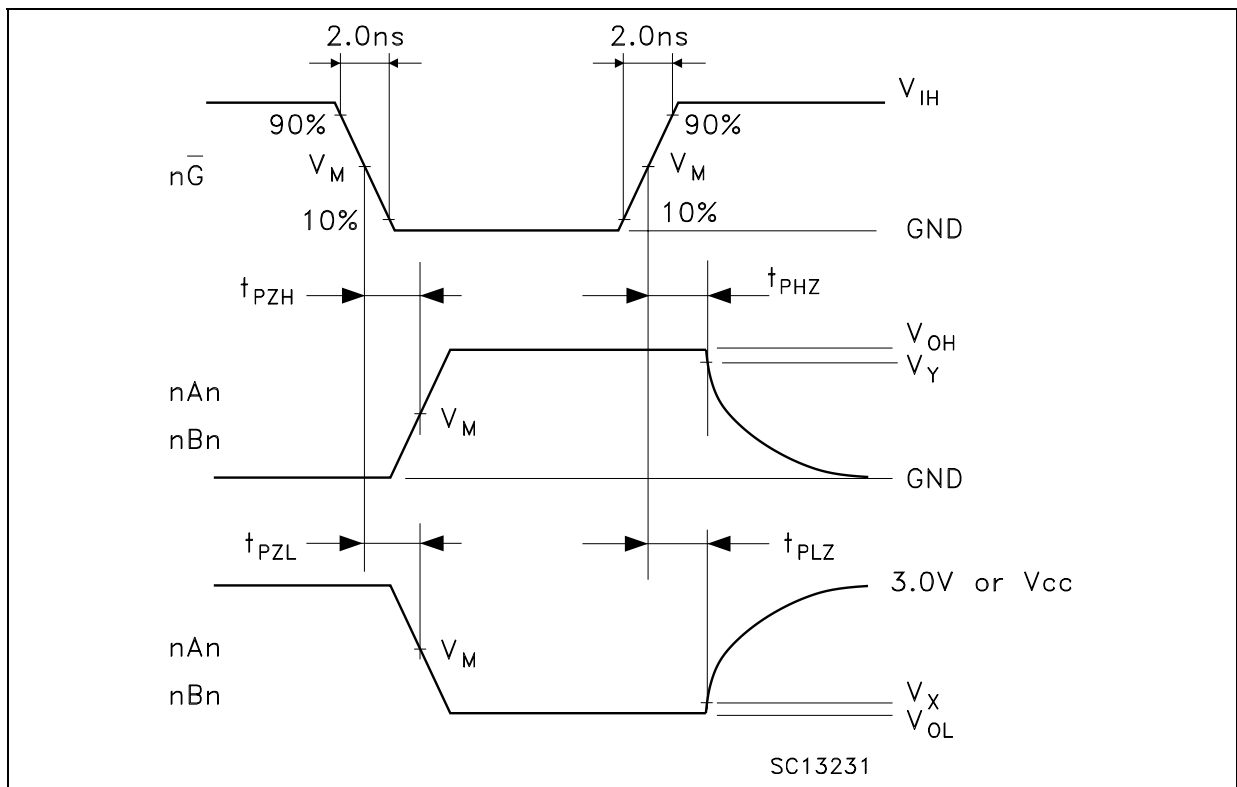
$C_L = 30pF$ or equivalent (includes jig and probe capacitance)

$R_L = R_1 = 500\Omega$ or equivalent

$R_T = Z_{OUT}$ of pulse generator (typically 50Ω)

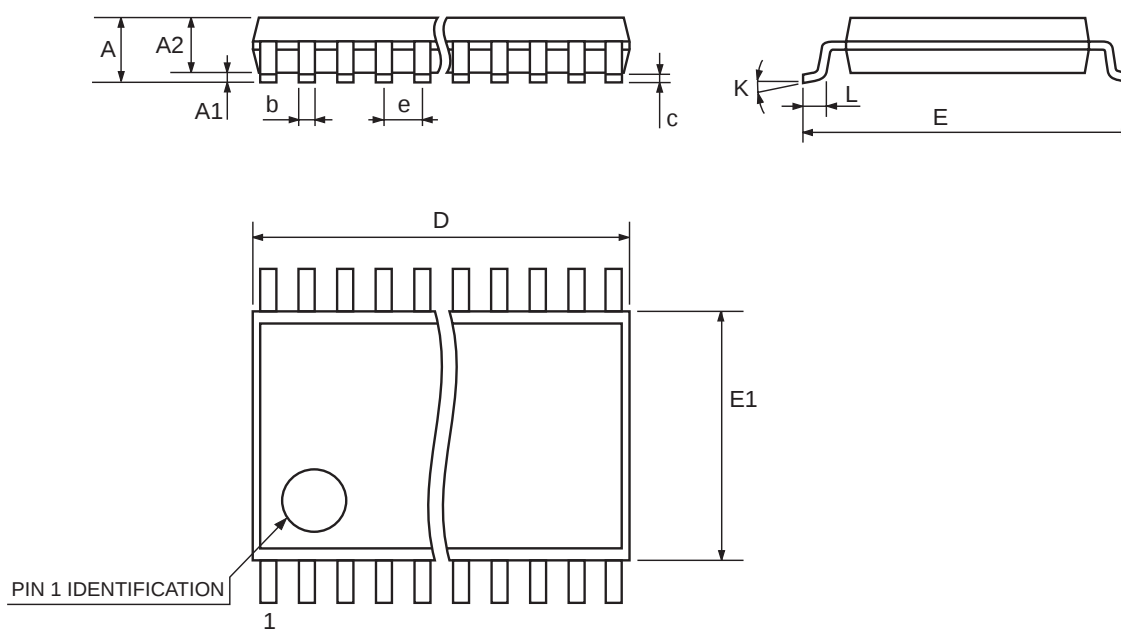
WAVEFORM SYMBOL VALUE

Symbol	V_{CC}		
	3.0 to 3.6V	2.3 to 2.7V	1.65 to 1.95V
V_{IH}	V_{CC}	V_{CC}	V_{CC}
V_M	1.5V	$V_{CC}/2$	$V_{CC}/2$
V_X	$V_{OL} + 0.3V$	$V_{OL} + 0.15V$	$V_{OL} + 0.15V$
V_Y	$V_{OL} - 0.3V$	$V_{OL} - 0.15V$	$V_{OL} - 0.15V$

WAVEFORM 1: PROPAGATION DELAY ($f=1\text{MHz}$; 50% duty cycle)**WAVEFORM 2: OUTPUT ENABLE AND DISABLE TIME** ($f=1\text{MHz}$; 50% duty cycle)

TSSOP48 MECHANICAL DATA

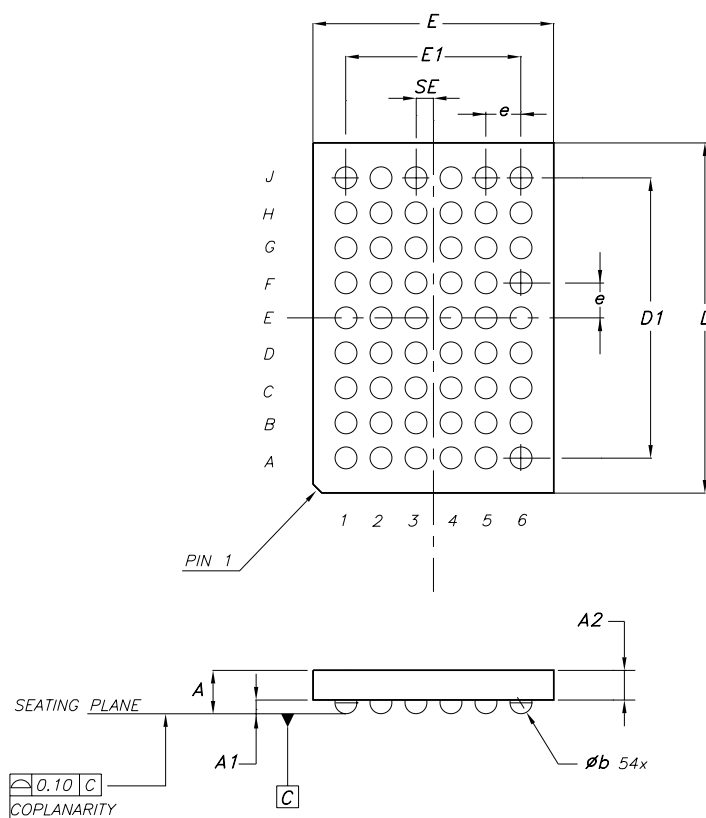
DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			1.2			0.047
A1	0.05		0.15	0.002		0.006
A2		0.9			0.035	
b	0.17		0.27	0.0067		0.011
c	0.09		0.20	0.0035		0.0079
D	12.4		12.6	0.488		0.496
E		8.1 BSC			0.318 BSC	
E1	6.0		6.2	0.236		0.244
e		0.5 BSC			0.0197 BSC	
K	0°		8°	0°		8°
L	0.50		0.75	0.020		0.030



7065588C

TFBGA54 MECHANICAL DATA

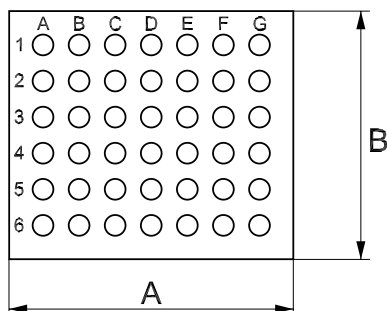
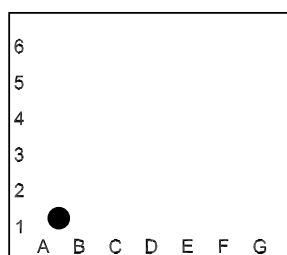
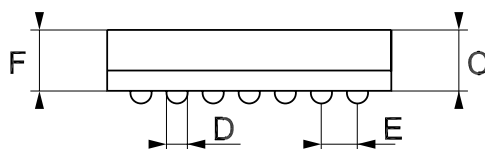
DIM.	mm.			mils		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			1.2			47.2
A1	0.25			9.8		
A2	0.78		0.86	30.7		33.8
B	0.35	0.4	0.45	13.7	15.7	17.7
D	7.9		8.1	311.0		318.9
D1		6.4			252.0	
E	5.4	5.5	5.6	212.6	216.5	220.5
E1		4			157.5	
e		0.8			31.5	
SE		0.4			15.7	



7390143/C

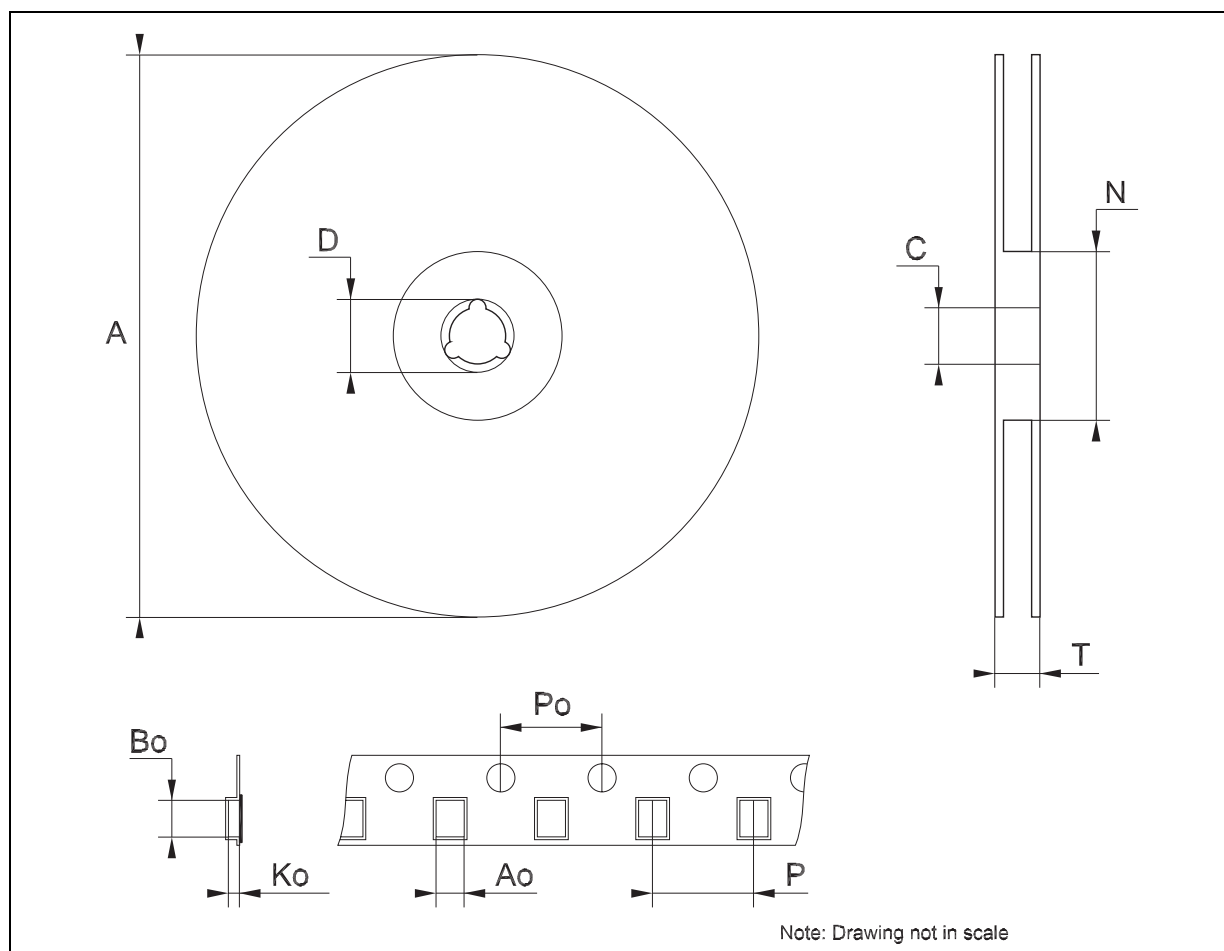
μTFBGA42 MECHANICAL DATA

DIM.	mm.			mils		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A	3.90		4.10	153.5		161.4
B	3.40		3.60	133.9		141.7
C		1.07	1.16		42.1	45.6
D		0.3			11.8	
E		0.5			19.7	
F	0.78		0.86	30.7		33.9



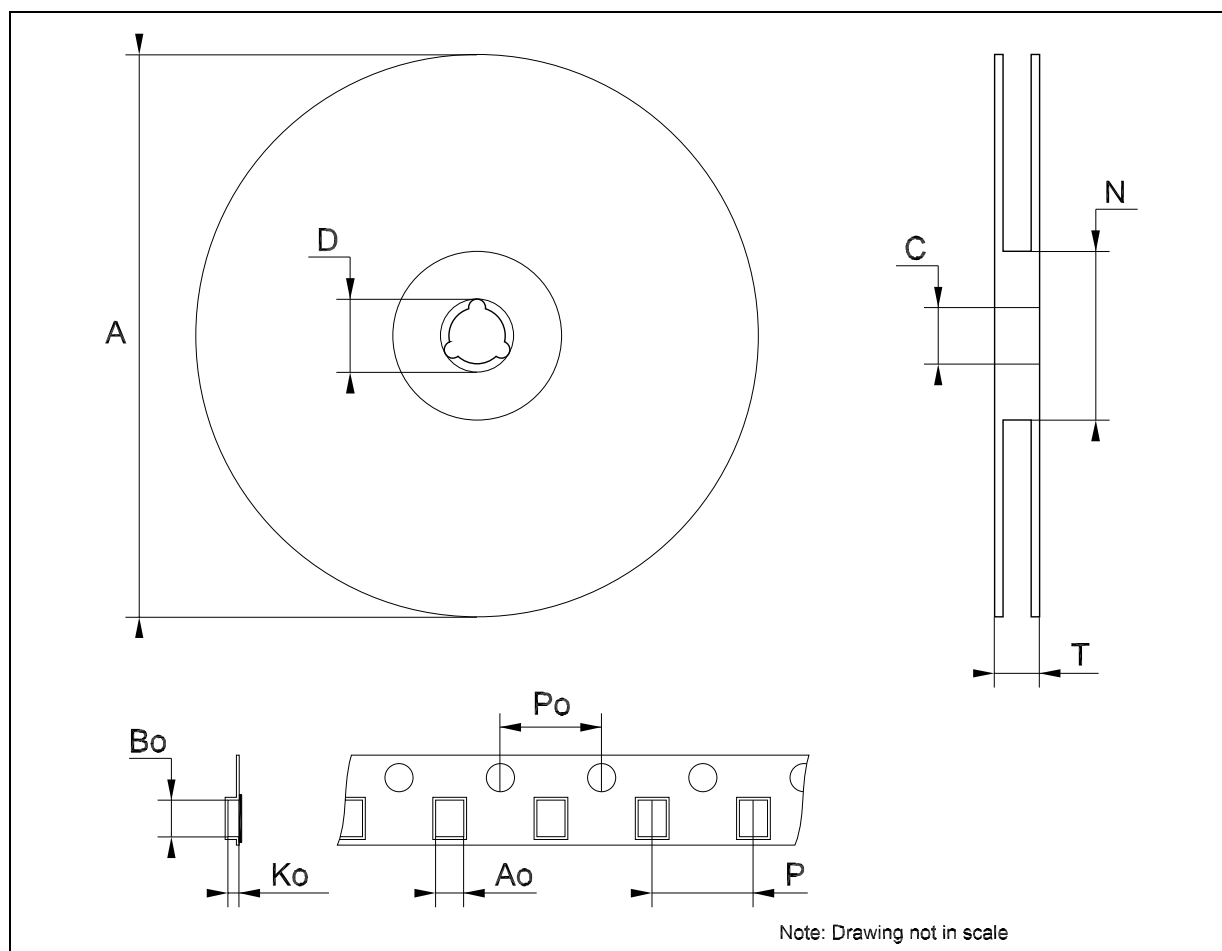
Tape & Reel TSSOP48 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			330			12.992
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
T			30.4			1.197
Ao	8.7		8.9	0.343		0.350
Bo	13.1		13.3	0.516		0.524
Ko	1.5		1.7	0.059		0.067
Po	3.9		4.1	0.153		0.161
P	11.9		12.1	0.468		0.476



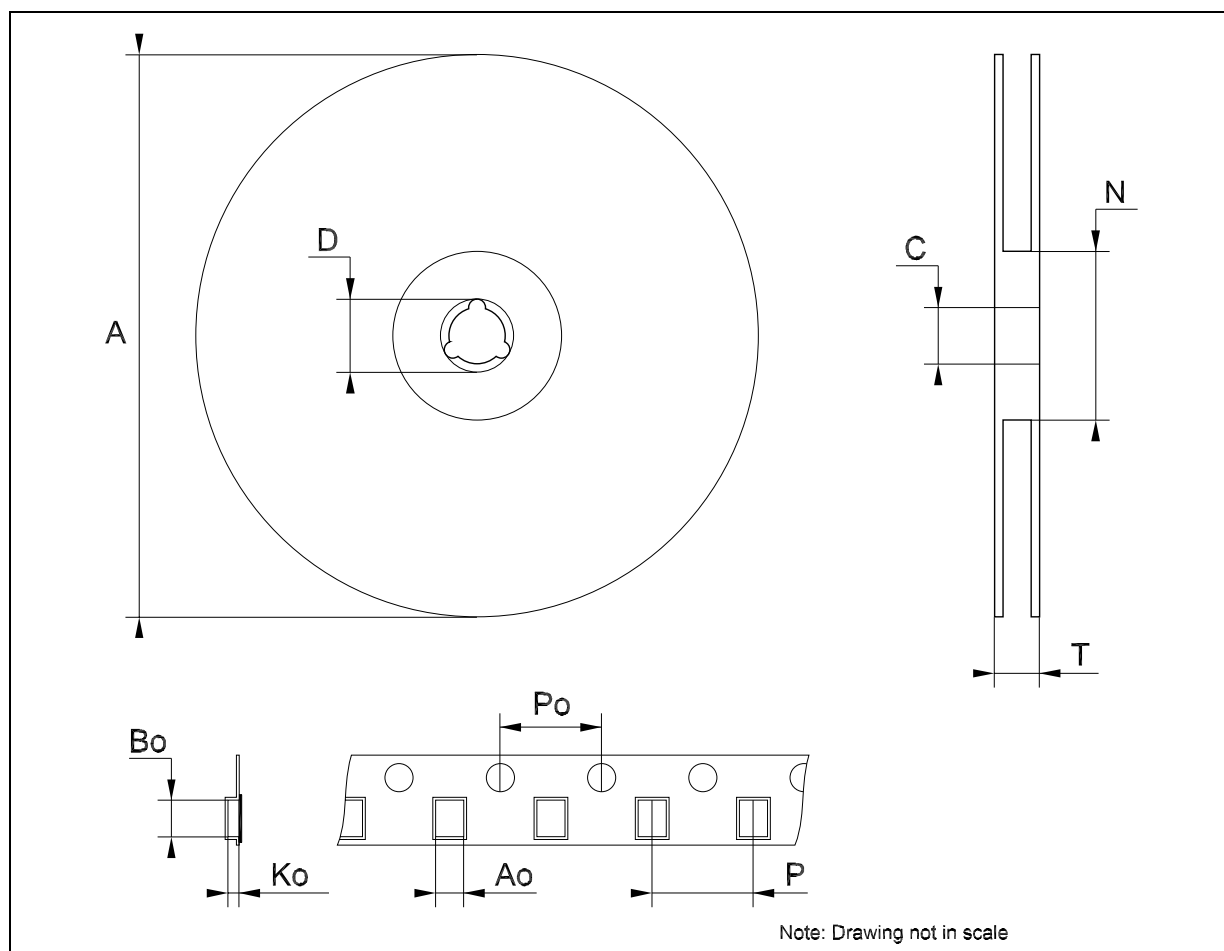
Tape & Reel TFBGA42 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			330			12.992
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
T			18.4			0.724
Ao		3.8			0.149	
Bo		4.3			0.169	
Ko		1.05			0.041	
Po	3.9		4.1	0.153		0.161
P	7.9		8.1	0.311		0.319



Tape & Reel TFBGA54 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			330			12.992
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
T			22.4			0.882
Ao		6.1			0.240	
Bo		8.6			0.339	
Ko		1.8			0.071	
Po	3.9		4.1	0.153		0.161
P	7.9		8.1	0.311		0.319



Information furnished is believed to be accurate and reliable. However, STMicroelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of STMicroelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. STMicroelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of STMicroelectronics.

The ST logo is a registered trademark of STMicroelectronics
All other names are the property of their respective owners

© 2003 STMicroelectronics - All Rights Reserved
STMicroelectronics GROUP OF COMPANIES

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States.

<http://www.st.com>